

L Number	Hits	Search Text	DB	Time stamp
1	227	((master with substrate) with cut\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/03 19:10
2	2	((master with substrate) with cut\$4) same TFT	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/03 19:10
3	7	((master with substrate) with cut\$4) same semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/03 19:12
4	1	((master with substrate) with cut\$4) same lcd	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/03 19:12

L Number	Hits	Search Text	DB	Time stamp
1	1897	fiducial adj mark	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/03 17:11
2	262	(fiducial adj mark) same substrate same align\$6	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/03 17:12
3	86	((fiducial adj mark) same substrate same align\$6) same pattern	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/03 17:13
4	68	((fiducial adj mark) same substrate same align\$6) same (pattern\$4 with align\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/03 17:25
5	210	(fiducial adj mark) same (pattern\$4 with align\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/03 17:26
6	68	((fiducial adj mark) same (pattern\$4 with align\$6)) same substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/03 17:26
7	17	(fiducial adj mark) same (pattern\$4 near align\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/03 17:26